VS-ST300C Series

Vishay Semiconductors





www.vishay.com

TO-200AB (E-PUK)

PRODUCT SUMMARY				
Package	TO-200AB (E-PUK)			
Diode variation	Single SCR			
I _{T(AV)}	650 A			
V _{DRM} /V _{RRM}	400 V to 2000 V			
V _{TM}	2.18 V			
I _{GT}	100 mA			
TJ	-40 °C to 125 °C			

FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (E-PUK)
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS				
PARAMETER	TEST CONDITIONS	VALUES	UNITS	
1		650	А	
I _{T(AV)}	T _{hs}	55	°C	
I		1290	А	
I _{T(RMS)}	T _{hs}	25	°C	
1	50 Hz	8000	٨	
ITSM	60 Hz	8380	A	
l ² t	50 Hz	320	kA ² s	
1-t	60 Hz	292	KA-S	
V _{DRM} /V _{RRM}		400 to 2000	V	
t _q	Typical	100	μs	
TJ		-40 to 125	°C	

ELECTRICAL SPECIFICATIONS

VOLTAGE R	VOLTAGE RATINGS							
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$I_{DRM}/I_{RRM} MAXIMUM AT T_J = T_J MAXIMUM mA$				
	04	400	500					
	08	800	900					
VS-ST300CC	12	1200	1300	50				
10 0100000	16	1600	1700	00				
	18	1800	1900					
	20	2000	2100					

 Revision: 25-Nov-13
 1
 Document Number: 94403

 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
 DiodesEurope@vishay.com

 THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000





VS-ST300C Series



www.vishay.com

Vishay Semiconductors

ABSOLUTE MAXIMUM RATING	5					
PARAMETER	SYMBOL		TEST CONDITIONS			UNITS
Maximum average on-state current	1	180° condu	ction, half sine v	vave	650 (320)	А
at heatsink temperature	I _{T(AV)}	double side	(single side) co	oled	55 (75)	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 25 °C	heatsink tempe	erature double side cooled	1290	
		t = 10 ms	No voltage		8000	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		8380	A kA ² s
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		6730	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	7040	
Martin	l ² t	t = 10 ms	No voltage	_	320	
		t = 8.3 ms	reapplied		292	
Maximum I ² t for fusing	1-1	t = 10 ms	100 % V _{RRM}		226	
		t = 8.3 ms	reapplied		207	
Maximum I ² \sqrt{t} for fusing	l²√t	t = 0.1 to 10) ms, no voltage	reapplied	3200	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x _{T(AV)} < l < \pi x$	I _{T(AV)}), T _J = T _J maximum	0.97	v
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$), T _J = T _J maxin	num	0.98	v
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), T _J = T _J maximum		0.74	- mΩ
High level value of on-state slope resistance	r _{t2}	$(I > \pi x I_{T(AV)}), T_J = T_J maximum$			0.73	1112.2
Maximum on-state voltage	V _{TM}	$I_{pk} = 1635 \text{ A}, T_J = T_J \text{ maximum, } t_p = 10 \text{ ms sine pulse}$		ium, t _p = 10 ms sine pulse	2.18	V
Maximum holding current	Ι _Η	T _ 05 °C	anada aunahi 1	2. V registive load	600	mA
Typical latching current	١L	$1_{\rm J} = 25$ C,	anoue supply 1	2 V resistive load	1000	mA

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega,t_r \leq 1~\mu s$ T_J = T_J maximum, anode voltage $\leq 80~\%~V_{DRM}$	1000	A/µs
Typical delay time	t _d	Gate current 1 A, dl _g /dt = 1 A/ μ s V _d = 0.67 % V _{DRM} , T _J = 25 °C	1.0	
Typical turn-off time	tq	I_{TM} = 300 A, T_J = T_J maximum, dl/dt = 40 A/µs, V_R = 50 V, dV/dt = 20 V/µs, gate 0 V 100 $\Omega,$ t_p = 500 µs	100	μs

BLOCKING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs		
Maximum peak reverse and off-state leakage current	I _{RRM,} I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	50	mA		



TRIGGERING						
		TE	TEST CONDITIONS		UES	UNITS
PARAMETER	SYMBOL		ST CONDITIONS	TYP.	MAX.	
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	t _p ≤ 5 ms	1(0.0	w
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	vv
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	t _p ≤ 5 ms	3	.0	А
Maximum peak positive gate voltage	+ V _{GM}		t < 5 mg	2	20	v
Maximum peak negative gate voltage	- V _{GM}	ij = ij maximum,	$T_J = T_J$ maximum, $t_p \le 5$ ms			v
		T _J = - 40 °C	Maximum required gate trigger/ current/voltage are the lowest value which will trigger all units 12 V anode to cathode applied	200	-	mA
DC gate current required to trigger	I _{GT}	T _J = 25 °C		100	200	
		T _J = 125 °C		50	-	
		T _J = - 40 °C		2.5	-	
DC gate voltage required to trigger	V_{GT}	T _J = 25 °C		1.8	3.0	V
		T _J = 125 °C		1.1	-	
DC gate current not to trigger	I _{GD}	T T movimum	Maximum gate current/voltage not to trigger is the maximum	10	0.0	mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J$ maximum	value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.	25	v

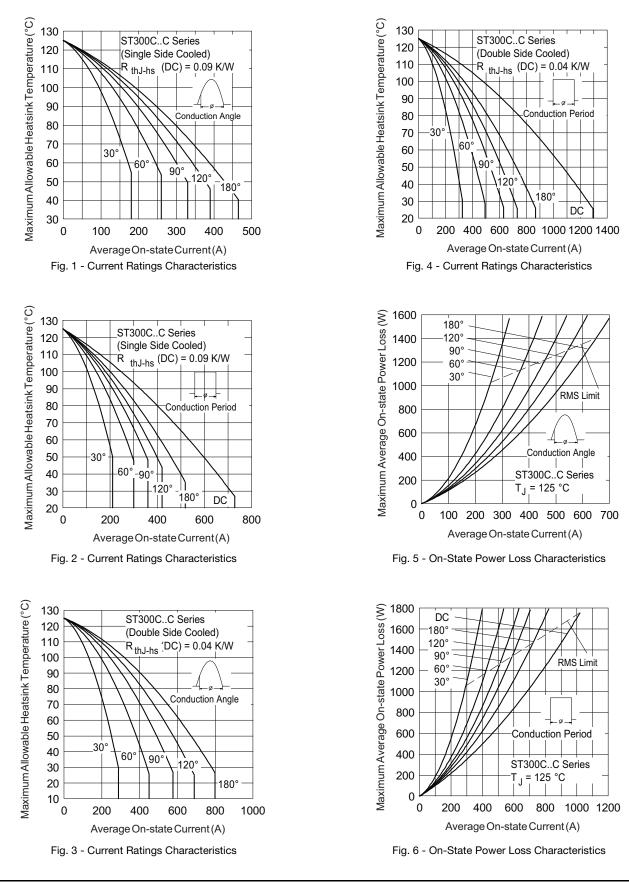
THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	TJ		- 40 to 125	°C	
Maximum storage temperature range	T _{Stg}		- 40 to 150	C	
Maximum thermal resistance, junction to heatsink	Р	DC operation single side cooled	0.09		
Maximum mermanesistance, junction to neatsink	R _{thJ-hs}	DC operation double side cooled	0.04	к/w	
Maximum thermal resistance, access to bestainly	Р	DC operation single side cooled	0.02	~~vv	
Maximum thermal resistance, case to heatsink	R _{thC-hs}	DC operation double side cooled	0.01		
Mounting force, ± 10 %			9800 (1000)	N (kg)	
Approximate weight			83	g	
Case style		See dimensions - link at the end of datasheet	TO-200AB (E-PUK)	

∆R_{thJ-hs} CONDUCTIO								
CONDUCTION ANGLE	SINUSOIDAL	SINUSOIDAL CONDUCTION		RECTANGULAR CONDUCTION		UNITS		
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS		
180°	0.010	0.011	0.007	0.007				
120°	0.012	0.012	0.012	0.013	T _J = T _J maximum			
90°	0.015	0.015	0.016	0.017		K/W		
60°	0.022	0.022	0.023	0.023				
30°	0.036	0.036	0.036	0.037				

Note

• The table above shows the increment of thermal resistance RthJ-hs when devices operate at different conduction angles than DC

Revision: 25-Nov-13 3 Document Number: 94403 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Revision: 25-Nov-13

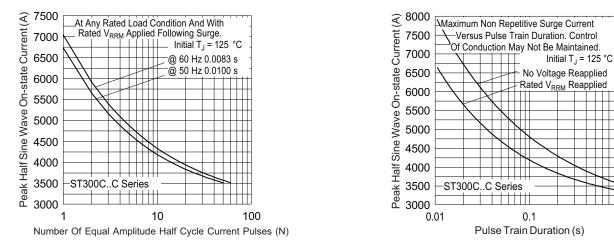
www.vishay.com

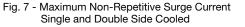
4

Document Number: 94403

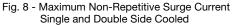
For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

1





www.vishay.com



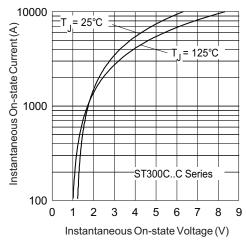
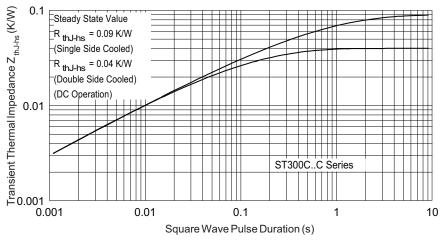


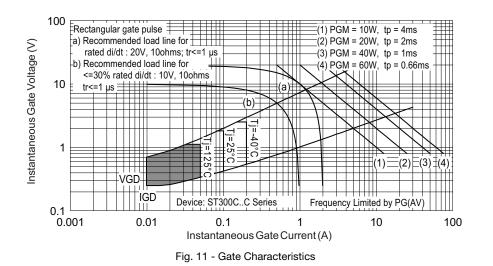
Fig. 9 - On-State Voltage Drop Characteristcs





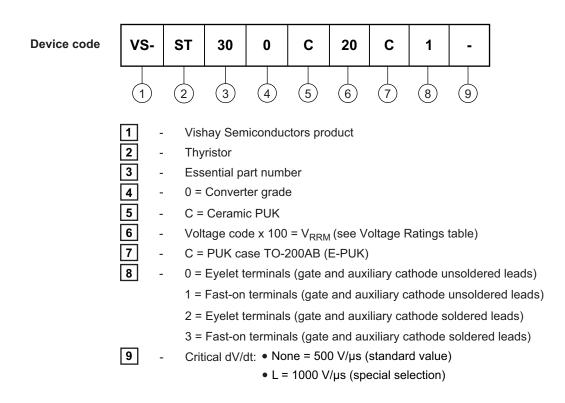
Revision: 25-Nov-13	5	Document Number: 94403
For technical questions within your region:	DiodesAmericas@vishay.com, DiodesAsia@vis	hay.com, DiodesEurope@vishay.com
	E WITHOUT NOTICE. THE PRODUCTS DESCR IFIC DISCLAIMERS, SET FORTH AT <u>www.vish</u> a	





ORDERING INFORMATION TABLE

www.vishay.com



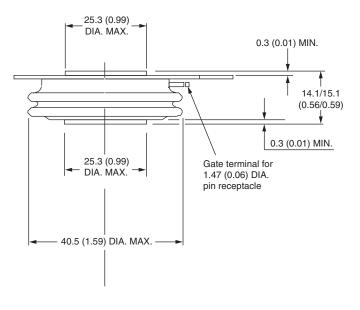
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95075			

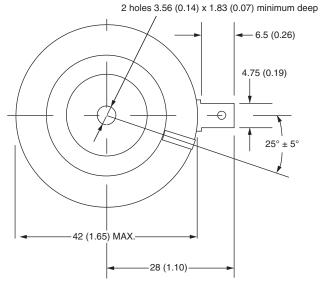


TO-200AB (E-PUK)

DIMENSIONS in millimeters (inches)

Anode to gate Creepage distance: 11.18 (0.44) minimum Strike distance: 7.62 (0.30) minimum





Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.